

Product and Process Change Notice

| PCN No. | PN02997 | PCN Date | 1/29/2018 | Effective Date | 4/30/2018 |
|------------|--------------------------------------------------------------|-------------|-----------|----------------|-----------|
| Title | Qualification of UTAC as an Assembly Site for BGA-24 Package | | | | |

Type: Major Change

Everspin is adding UTAC Dongguan (UDG) as a qualified assembly site for the BGA-24 package. UDG is already an approved supplier for Everspin BGA packages on other similar products.

Reason For Change

To increase capacity and improve supply flexibility.

Affected Products

| Part Number | Description | Part Number | Description |
|-------------|------------------|--------------|-----------------------|
| MR10Q010MB | Commercial Temp. | MR10Q010MBR | Commercial Temp., T&R |
| MR10Q010CMB | Industrial Temp. | MR10Q010CMBR | Industrial Temp., T&R |
| MR10Q010VMB | Extended Temp. | MR10Q010VMBR | Extended Temp., T&R |

Impact on Form, Fit, Function, Quality or Reliability

No impact

Proposed First Ship Date for Change:

April 30, 2018

Key Material Differences

| | Site | | |
|------------|------------------------|-------------------------|--|
| Material | UTAC Dongguan | ASE | |
| Bond Wire | Au Wire, 0.8 mil | Au Wire, 0.9 mil | |
| BLT1 Epoxy | Ablestik QMI536NB | Ablestik Ablebond 2025D | |
| BLT2 Epoxy | Hitachi FH-9011-25 DAF | Hitachi FH-9011-25 DAF | |
| BLT3 Epoxy | Ablestik QMI536NB | Dow Corning 7920 | |

Product Identifier

Assembly site code = G for UTAC Dongguan

Supplier Qual Plan Schedule and Results

UTAC Dongguang (UDG) assembly line qualification is complete and all Everspin requirements have been met; a qualification report is available on request.

Date Qualification Samples Are Available:

Samples are generally available now but please request your specific part number to your Everspin Sales contact.

Acceptance of Change

Everspin will consider this change accepted unless specific conditions for acceptance are provided in writing within 30 days of receipt of this notice.



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| Contact Information | | Sample Information Samples | s Available Now | | |
|----------------------------------------------------------------------------------------------------|----------------------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|----------------------------|--|--|
| Joe O'Hare Director, Product Marketing Everspin Technologies joe.ohare@everspin.com (512) 828-3357 | | Contact Everspin sales: http://www.everspin.com/contact-us-everspin-technologies If using the on-line sample request please refer to this PCN # to receive samples. | | | |
| Originator | | | | | |
| <u>Date</u> 1/22/2018 | | eting Director | Name Joe O'Hare | | |
| Approval and Release | Approval and Release | | | | |
| Date Title 1/29/2018 Qualit | | y Engineer | <u>Name</u> Paul Drobny | | |
| <u>Date</u> <u>Title</u> 1/29/2018 VP of | | Sales and Marketing | <u>Name</u> Annie Flaig | | |
| Date Title 1/29/2018 VP of | | Operations | <u>Name</u> Norm Armour | | |